

POWER MANAGEMENT
Features

- Input voltage range — 2.9V to 5.5V
- V_{OUT} tolerance — $5.3V \pm 3\%$
- Continuous output current — 275mA, $V_{IN}=3V$
- Peak output current — 400mA
- Three charge pump modes — 1x, 1.5x and 2x
- Output ripple $\leq 40mV_{PP}$ for $I_{OUT} \leq 400mA$
- Short circuit, over-voltage, and over-temperature protection
- Soft-start functionality
- Shutdown current — 0.1 μA , typical
- Ultra thin package — 2 x 2 x 0.6 (mm)
- Lead-free and halogen-free
- WEEE and RoHS compliant

Applications

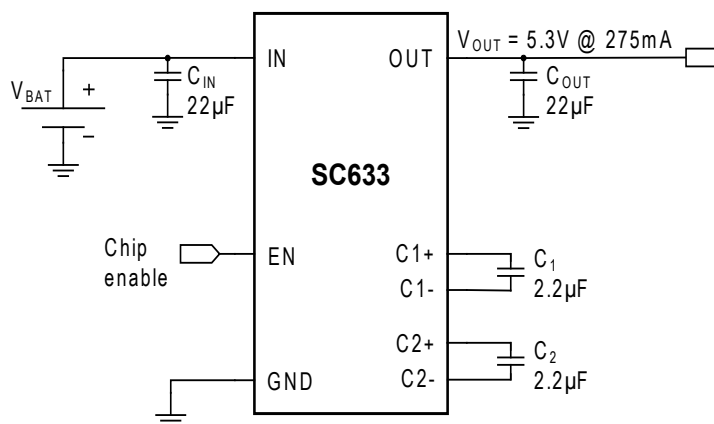
- Mobile phones
- MP3 players
- USB On-The-Go
- Multi-LED backlit LCDs
- Compact flash/CF+ products
- PMPs
- Digital video cameras
- Digital still cameras
- PDAs

Description

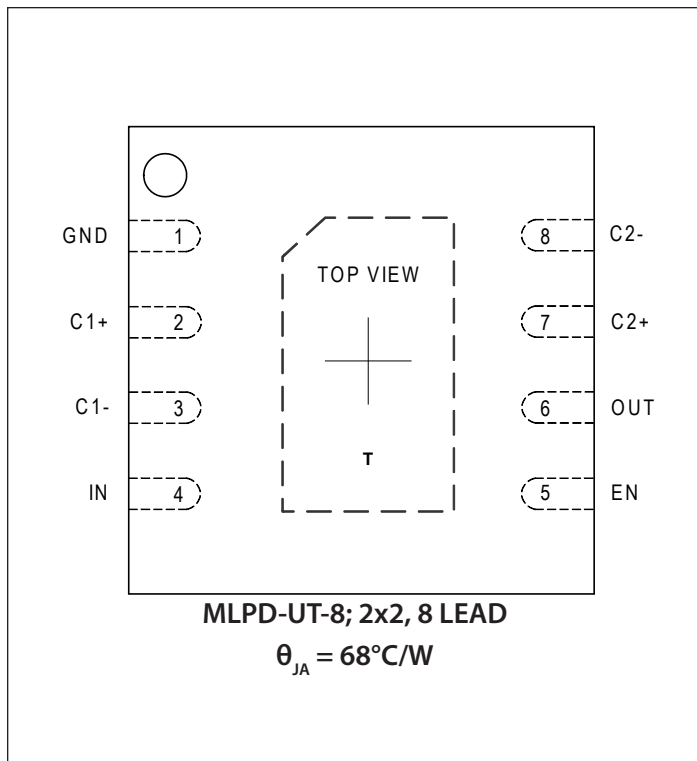
The SC633 is a high-current voltage regulator using Semtech's proprietary low-noise charge pump technology. Performance is optimized for use in single Li-Ion battery cell applications. The regulator provides the performance of a linear, low drop-out (LDO) voltage regulator when the input is greater than 5.3V. Unlike an LDO, drop-out is avoided when the input is less than 5.3V. Instead, a charge pump is activated to provide voltage boost and the head-room needed for voltage regulation.

Only two 2.2 μF bucket capacitors are required to deliver the full output current. The charge pump provides a low EMI solution compared to inductive boost regulators.

The SC633's charge pump has three modes of operation: 2x, 1.5x, and 1x modes. The 2x and 1.5x modes deliver current to the load in each of two phases. The 1x mode turns off the charge pump, delivering current through an LDO. When active, the charge pump provides low-ripple operation at 200kHz, which is typically less than 30mVpp at the output. The SC633 is capable of delivering 275mA continuous current, with peak current to 400mA. A 22 μF output capacitor is used for decoupling the load and for smoothing mode transitions. Hysteresis is provided to prevent chatter between charge pump modes.

Typical Application Circuit


Pin Configuration



Ordering Information

| Device | Package |
|------------------------------|------------------|
| SC633ULTRT ⁽¹⁾⁽²⁾ | MLPD-UT-8 2x2 |
| SC633EVB | Evaluation Board |

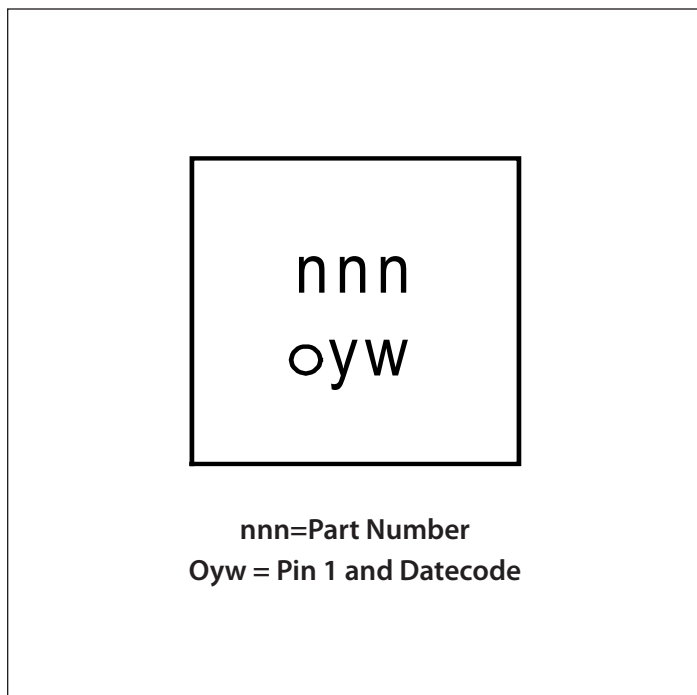
Notes:

- (1) Available in tape and reel only. A reel contains 3,000 devices.
- (2) Lead-free packaging only. Device is WEEE and RoHS compliant, and halogen-free.

Device Options

| Part Num | nnn | Features |
|----------|-----|---|
| SC630A | K0A | 1 MHz, 3.3V, smaller C_{in} and C_{out} |
| SC632A | K2A | 1 MHz, 5V, smaller C_{in} and C_{out} |
| SC632 | 632 | 200 kHz, 5.0V |
| SC630 | 630 | 200 kHz, 3.3V |
| SC633 | 633 | 200 kHz, 5.3V |

Marking Information



Absolute Maximum Ratings

| | |
|--|-----------------------------|
| IN (V) | -0.3 to +6.0 |
| OUT (V)..... | -0.3 to +6.0 |
| C1+, C2+ (V) | -0.3 to ($V_{OUT} + 0.3$) |
| Pin Voltage — All Other Pins (V) | -0.3 to ($V_{IN} + 0.3$) |
| OUT pin — Short Circuit Duration | Continuous |
| ESD Protection Level ⁽²⁾ (kV) | 2 |

Recommended Operating Conditions

| | |
|--------------------------------------|----------------------------|
| Ambient Temperature Range (°C) | $-40 \leq T_A \leq +85$ |
| IN (V) | $2.9 \leq V_{IN} \leq 5.5$ |

Thermal Information

| | |
|--|-------------|
| Thermal Resistance, Junction to Ambient ⁽¹⁾ (°C/W) | 68 |
| Maximum Junction Temperature (°C) | +150 |
| Storage Temperature Range (°C) | -65 to +150 |
| Peak IR Reflow Temperature (10s to 30s) (°C) | +260 |

Exceeding the above specifications may result in permanent damage to the device or device malfunction. Operation outside of the parameters specified in the Electrical Characteristics section is not recommended.

NOTES

(1) Calculated from package in still air, mounted to 3 x 4.5 (in), 4 layer FR4 PCB with thermal vias under the exposed pad per JESD51 standards.

(2) Tested according to JEDEC standard JEDEC22-A114-B.

Electrical Characteristics

Unless otherwise specified: $T_A = +25^\circ\text{C}$ for Typ, -40°C to $+85^\circ\text{C}$ for Min and Max; $C_1 = C_2 = 2.2\mu\text{F}$ (ESR < 0.03Ω); $C_{IN} = C_{OUT} = 22\mu\text{F}$; $V_{IN} = 2.9\text{V}$ to 5.5V

| Parameter | Symbol | Condition | Min | Typ | Max | Units |
|-------------------------|-------------------|--|------|-----|------|-------|
| Output Voltage | V_{OUT} | $V_{IN} = 4.2\text{V}$, $I_{OUT} = 1\text{mA}$ | 5.14 | 5.3 | 5.46 | V |
| Output Voltage Ripple | V_{PP} | $I_{OUT} \leq 400\text{mA}$ | | 40 | | mV |
| Maximum Output Current | I_{OUT} | Peak Load - thermally limited ⁽¹⁾ , $T_J < 150^\circ\text{C}$, $3.3\text{V} \leq V_{IN} \leq 5.0\text{V}$ | 400 | | | mA |
| | | Continuous Load, $3.10\text{V} \leq V_{IN} \leq 4.2\text{V}$ | 275 | | | mA |
| Shutdown Current | I_{SD} | Shutdown (EN = GND), $V_{IN} = 3.6\text{V}$ | | 0.1 | 2 | μA |
| Total Quiescent Current | I_Q | EN high, $I_{OUT} = 1\text{mA}$, $V_{IN} = 4.2\text{V}$ | | 1.5 | 2.5 | mA |
| Charge Pump Frequency | f_{PUMP} | $V_{IN} = 3.2\text{V}$ | 140 | 200 | 260 | kHz |
| Start-Up Time | t_{SU} | (EN transitions from low to high), $5.14\text{V} \leq V_{OUT} \leq 5.46\text{V}$, No load | | 400 | | μs |
| Line Regulation | ΔV_{LINE} | $I_{OUT} = 1\text{mA}$, $2.85\text{V} \leq V_{IN} \leq 4.2\text{V}$ | | | 21 | mV |
| Load Regulation | ΔV_{LOAD} | $V_{IN} = 4.2\text{V}$, $1\text{mA} \leq I_{OUT} \leq 400\text{mA}$ | | | 37.5 | mV |
| EN Input High Threshold | V_{IH} | $V_{IN} = 5.5\text{V}$ | 1.6 | | | V |

Electrical Characteristics (continued)

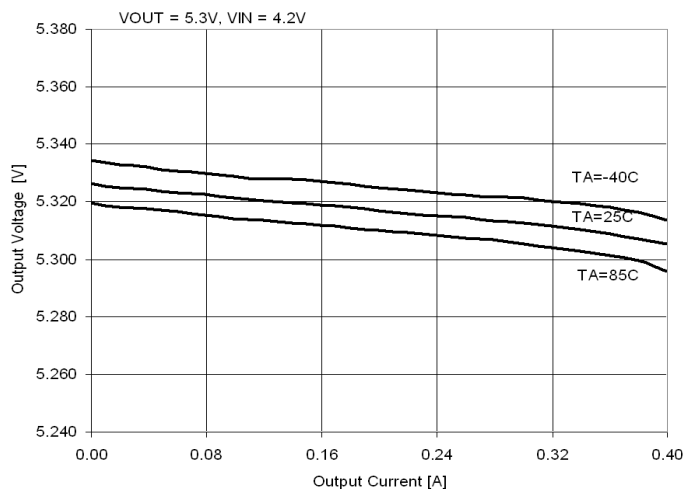
| Parameter | Symbol | Condition | Min | Typ | Max | Units |
|--|-------------------|--------------------------------------|-----|------|-----|-------------|
| EN Input Low Threshold | V_{IL} | $V_{IN} = 2.7V$ | | | 0.4 | V |
| EN Input High Current | I_{IH} | $V_{IN} = 5.5V$ | | | 2 | μA |
| EN Input Low Current | I_{IL} | $V_{IN} = 5.5V$ | | | 2 | μA |
| Open-Loop Output Resistance | R_{OUT} | 1x mode | | 0.25 | | Ω |
| | | 1.5x mode, $V_{IN} = 3.7V$ | | 2.85 | | Ω |
| | | 2x mode, $V_{IN} = 3.1V$ | | 2.9 | | Ω |
| Mode Transition Voltage ⁽²⁾ | $V_{TRANS\ 1X}$ | $I_{OUT} = 200mA$ | | 5.32 | | V |
| | $V_{TRANS\ 1.5X}$ | $I_{OUT} = 200mA$ | | 3.86 | | V |
| Fault Protection | | | | | | |
| Short-Circuit Current | I_{SC} | $V_{OUT} = 0V, I_{OUT} = I_{IN}$ | 300 | 600 | 980 | mA |
| Input Current Limit | I_{LIMIT} | $V_{OUT} > 2V, 1x\ mode$ | 0.6 | 1.2 | 2.0 | A |
| | | $V_{OUT} > 2V, 1.5x\ and\ 2x\ modes$ | 1.2 | 2.0 | 2.8 | A |
| | | $V_{OUT} \leq 2V, I_{OUT} = I_{IN}$ | | 700 | | mA |
| Over Temperature | T_{OTP} | Rising Threshold | | 165 | | $^{\circ}C$ |
| | T_{HYS} | Hysteresis ⁽³⁾ | | 20 | | $^{\circ}C$ |

Notes:

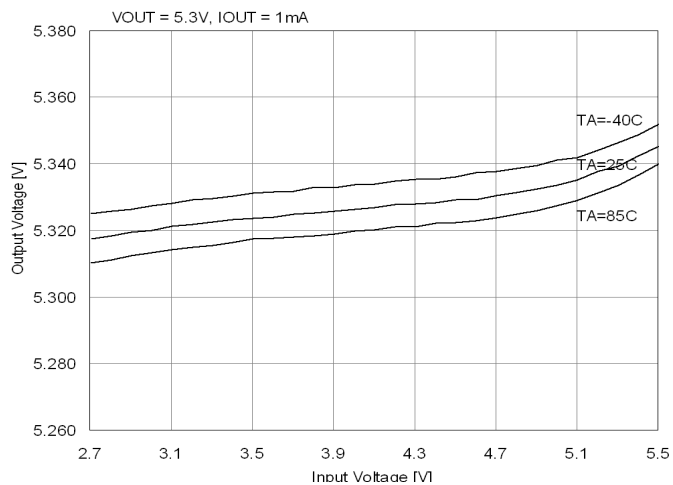
- (1) Thermal limitation is dependent upon the thermal performance of the printed circuit board in support of the package standard of 68 $^{\circ}C/W$.
- (2) Voltage at the IN pin where a mode transition takes place in the charge pump with V_{IN} falling.
- (3) Guaranteed by design — not tested in production.

Typical Characteristics

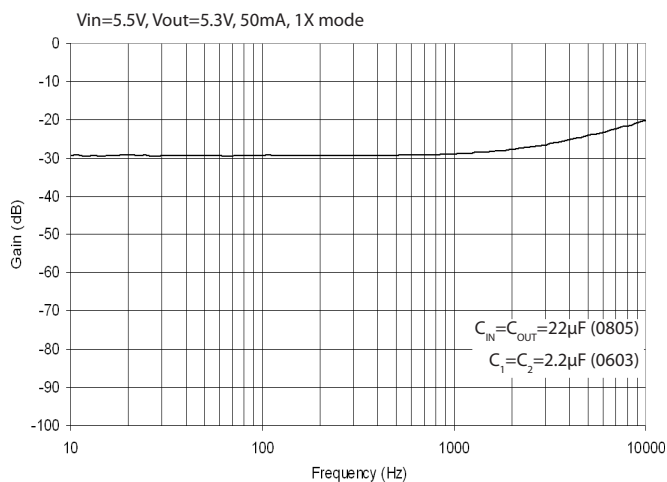
Load Regulation



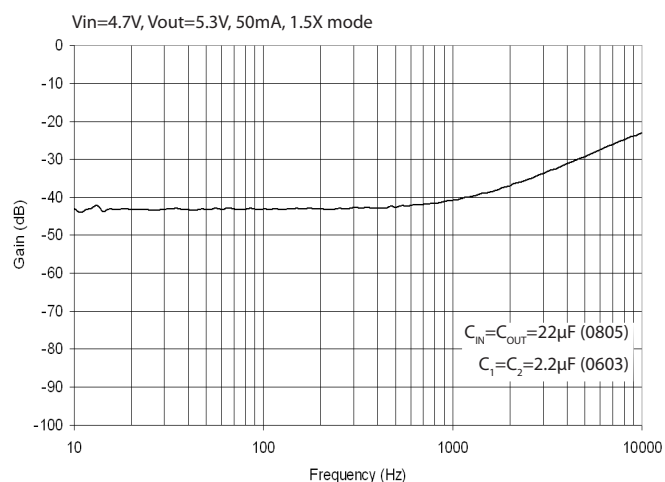
Line Regulation



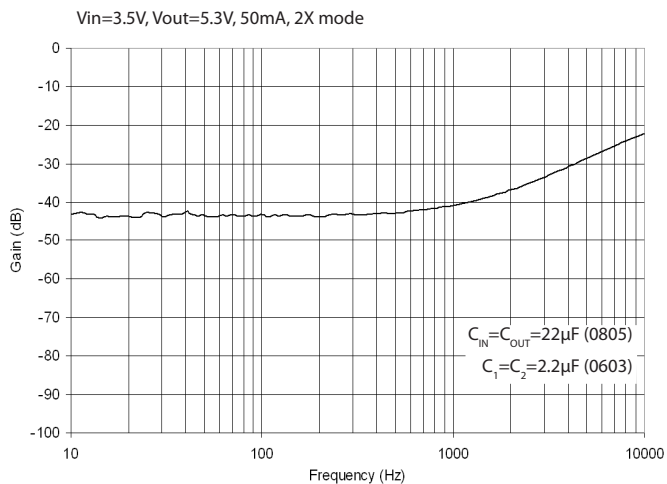
PSRR versus Frequency — 1.0x Mode



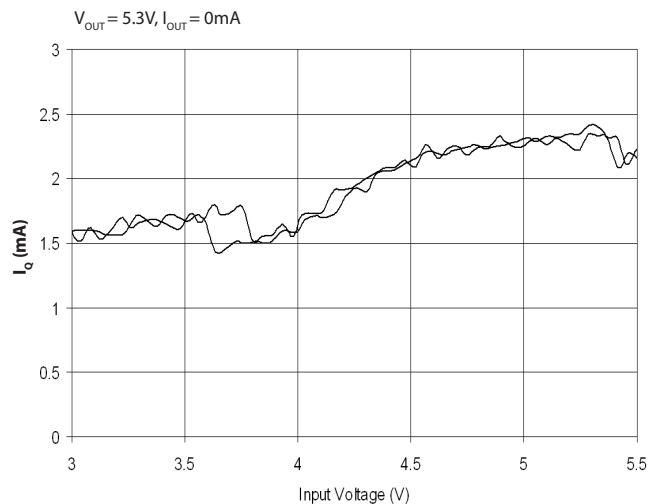
PSRR versus Frequency — 1.5x Mode



PSRR versus Frequency — 2x Mode

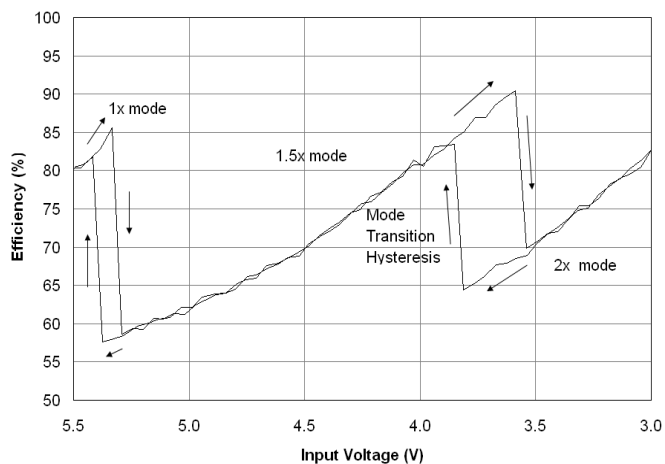


Quiescent Current

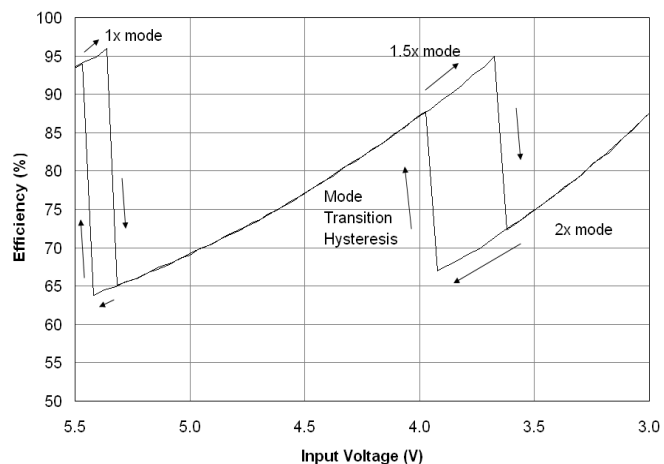


Typical Characteristics (continued)

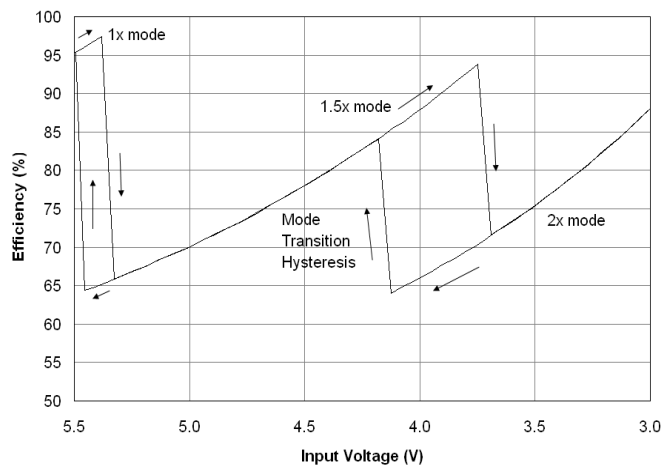
Efficiency — 10mA



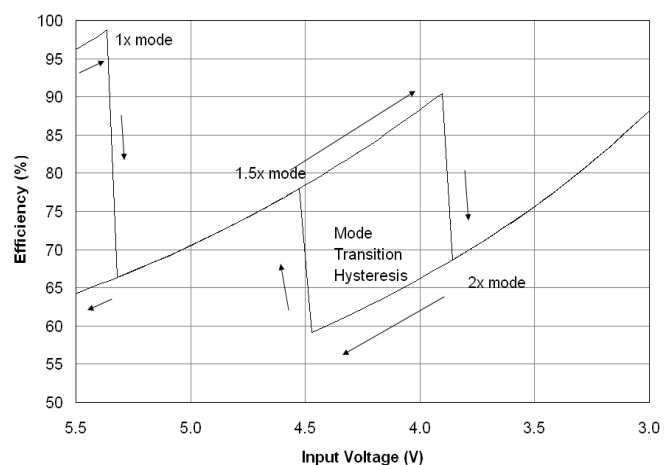
Efficiency — 50mA



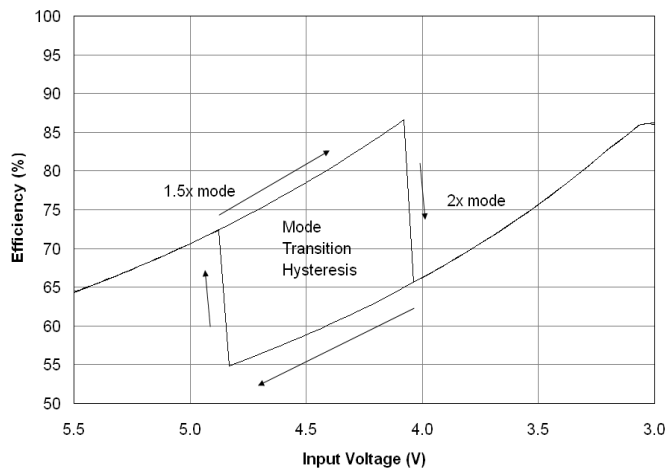
Efficiency — 100mA



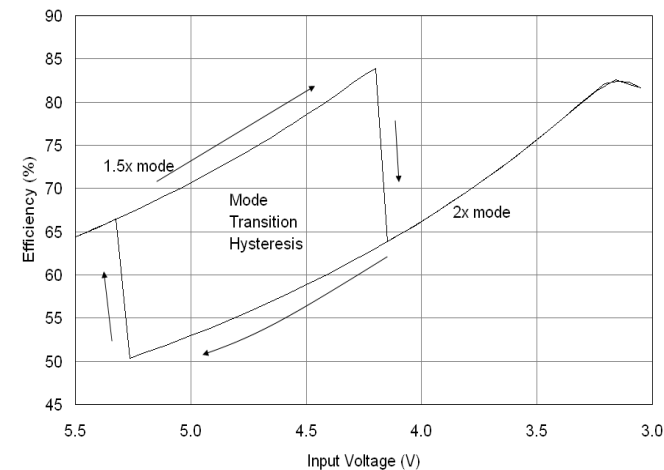
Efficiency — 200mA



Efficiency — 300mA

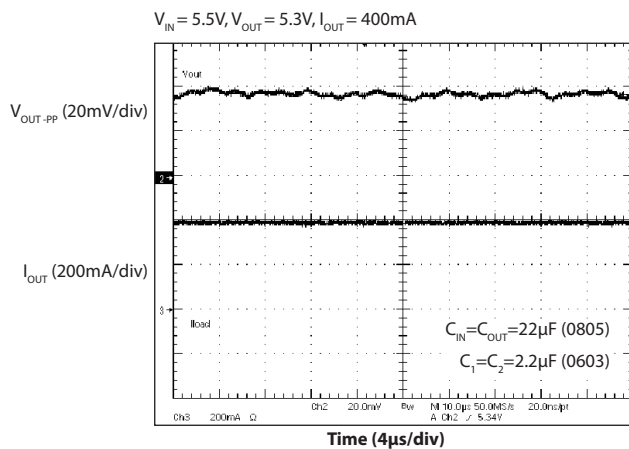


Efficiency — 400mA

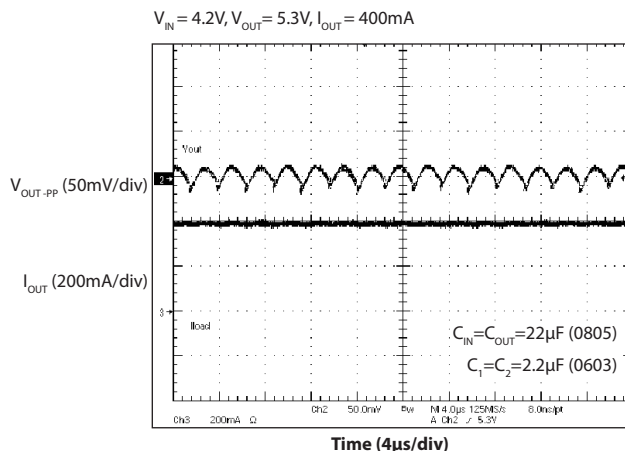


Typical Characteristics (continued)

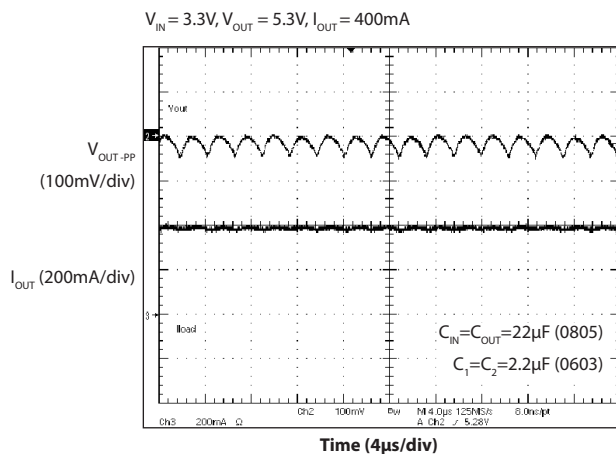
Ripple — 1x Mode



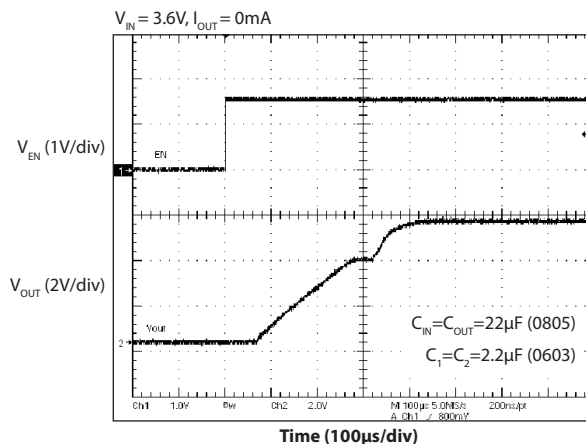
Ripple — 1.5x Mode



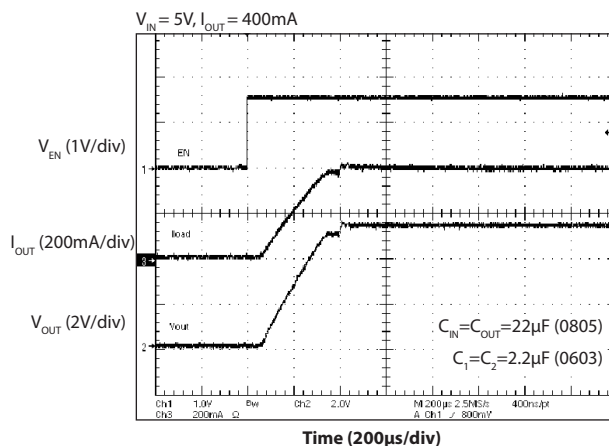
Ripple — 2x Mode



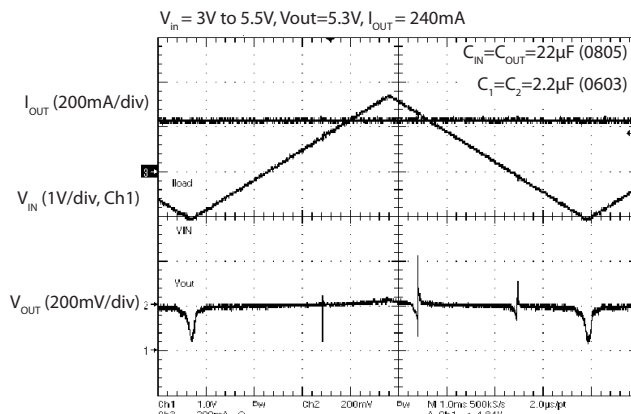
Startup (No Load)



Startup (400mA)



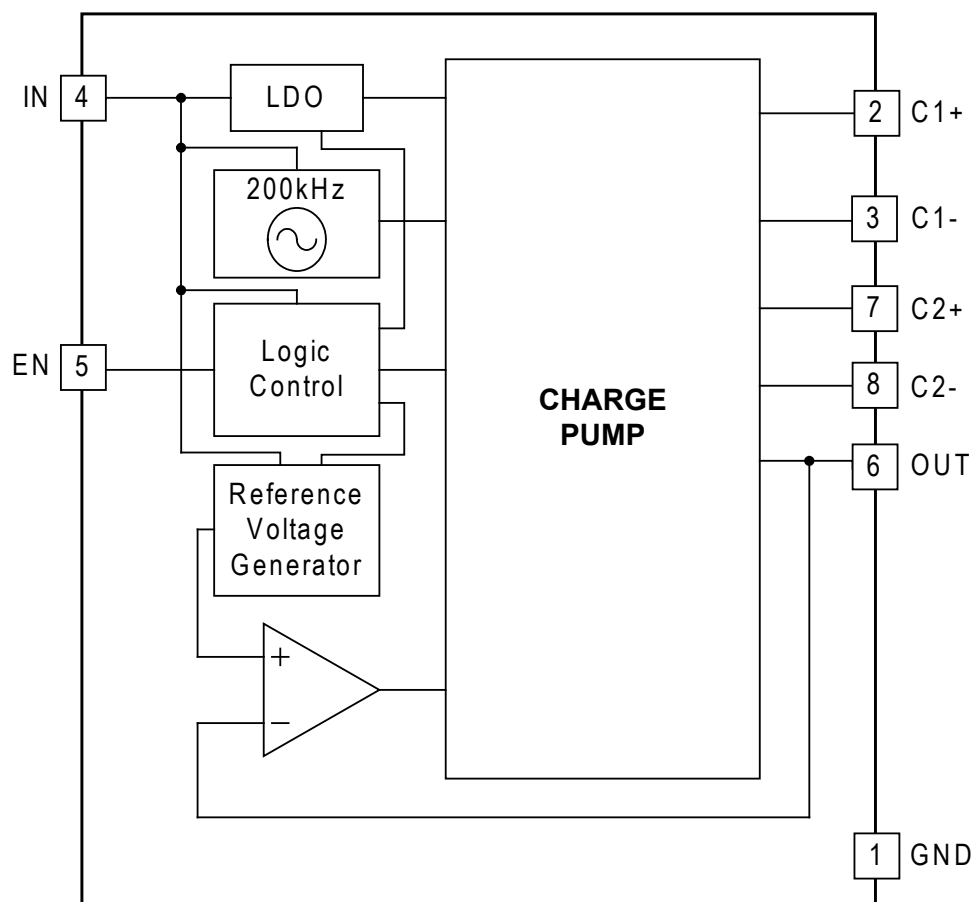
Mode Transition at Load = 240mA



Pin Descriptions

| Pin | Pin Name | Pin Function |
|-----|-------------|---|
| 1 | GND | Ground — connect to ground plane with multiple vias |
| 2 | C1+ | Positive terminal of bucket capacitor 1 |
| 3 | C1- | Negative terminal of bucket capacitor 1 |
| 4 | IN | Input supply voltage |
| 5 | EN | Chip enable — active-high |
| 6 | OUT | Output |
| 7 | C2+ | Positive terminal of bucket capacitor 2 |
| 8 | C2- | Negative terminal of bucket capacitor 2 |
| T | Thermal Pad | This pad is for heat sinking and is not connected internally. It must be connected to a ground plane using multiple vias. |

Block Diagram



Applications Information

General Description

The SC633 is a 5.3V output charge pump regulator designed to support up to peak current of 400mA ($T_A \leq 55^\circ\text{C}$, $3.3\text{V} \leq V_{IN} \leq 4.2\text{V}$) and 275mA ($T_A \leq 85^\circ\text{C}$, $3.15\text{V} \leq V_{IN} \leq 5.5\text{V}$) of continuous current for powering 5.0V devices in portable handheld equipment including Compact Flash and CF+ products.

The SC633 has three operating modes — 1x, 1.5x, and 2x. The 1x mode is a linear series regulation mode with a low open-loop output resistance of only 250mΩ. The 1x mode functions as a low-noise series linear regulator. The 1.5x and 2x modes are a low noise, constant frequency, constant duty cycle switch mode, using two bucket capacitors. One bucket supports the full output current while the other bucket charges from the input. The two buckets exchange roles in the next phase, supplying continuous output current in both phases and reducing the need for a large output decoupling capacitor. The constant frequency, constant duty cycle operation also produces predictable constant frequency harmonics.

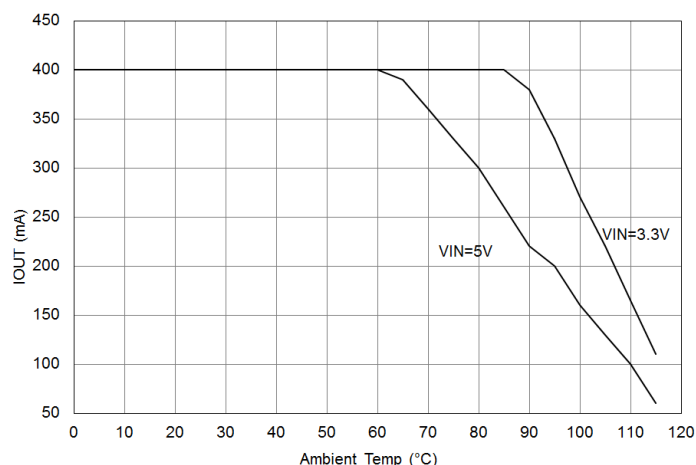
Thermal Resistance

The SC633 package is thermally efficient when the circuit board layout connects the thermal pad through multiple vias to the ground plane. The thermal resistance rating is dependent upon the connection between the thermal pad and the ground plane. A layout that is done correctly should keep the junction temperature below the over-temperature limit while operating the SC633 within the specified electrical conditions. A poor layout may allow the junction temperature to reach the over temperature limit, so it is important to maintain adequate ground plane around the device to maximize heat transfer to the PCB.

Temperature Derating

The maximum power dissipation of the package can be calculated by the difference between the junction temperature of 150 degree and the ambient temperature divided by the thermal impedance 68 °C/W. The higher the ambient temperature, the lower the maximum allowable power dissipation. At a given V_{IN} condition, the allowable power dissipation will correlates to the specific

output current related to the operation efficiency. The following derating curve is obtained based on efficiency at input voltage of 5V and 3.3V. For any input conditions, due to the mode hysteresis, SC633 operation mode might be determined from its previous operation voltage, it could be in 1X, 1.5X, or 2X mode. The low efficiency should always be used for worst case consideration. In this case, at $V_{IN}=3.3\text{V}$, SC633 operates in 2X mode. At $V_{IN}=5\text{V}$, SC633 operates either in 2X or 1.5X mode. In the derating curve below, the DC operating points beneath each curve are in the safe operating temperature range of the MLP package.



Maximum Continuous Output

Mode Transition

As input voltage varies, the SC633 will experience mode transitions. The transition threshold changes with input voltage and load conditions. The mode change hysteresis at several load current conditions are shown in the operating curves on page 6. Mode transition will bring output voltage dip or overshoots. The output voltage deviation in mode transition can be improved by using larger output capacitors if the output voltage going beyond the regulation range.

Mode Transition Hysteresis

Hysteresis is provided to prevent chatter between charge pump modes for input steps of up to 120mV. Decouple the input to prevent steps greater than 120mV, for

Applications Information (continued)

optimum transient performance, when the input voltage reaches the mode transition thresholds.

Protection Circuitry

The SC633 also provides protection circuitry that prevents the device from operating in an unspecified state. These functions include:

- Over-Current Protection (OCP)
- Short-Circuit Current Protection (SCCP)
- Over-Temperature Protection (OTP)

Over-Current Protection

Over-current protection is provided to limit the output current. When V_{OUT} is greater than 2V, OCP limits the output to 1A typical. The threshold at 2V allows the device to recover from excessive voltage droop during an over current.

Short-Circuit Current Protection

Short-circuit current protection is provided to limit the current that can be sourced when the output is shorted to ground. When a short circuit forces V_{OUT} to drop below 2V, the SCCP detects the condition and limits the output current to 600mA (typical).

Over-Temperature Protection

The over-temperature circuit helps prevent the device from overheating and experiencing a catastrophic failure. When the junction temperature exceeds 165°C, the device is disabled. It remains disabled until the junction temperature drops below this threshold. Hysteresis is included

that prevents the device from re-enabling until the junction temperature is reduced by 20°C.

Capacitor Selection

The SC633 is designed to use low-ESR ceramic capacitors for the input and output bypass capacitors as well as the charge pump bucket capacitors. Ideal performance is achieved when the bucket capacitors are exactly equal. The value of input and output decoupling capacitors will vary with system requirements. For best ripple performance C_{IN} and C_{OUT} are normally 22μF and the bucket capacitors C_1 and C_2 are 2.2μF. For low profile designs, two 10μF capacitors may be used in place of each 22μF.

When selecting capacitors for an application, first consider the DC voltage characteristic of the capacitor. The value of capacitance at the DC operating voltage may be considerably lower than the rated value. The following table lists recommended capacitor values which have been chosen to minimize the impact of this limitation.

Table 1 — Recommended Capacitors

| Capacitor | Value μF | Case Size | Notes |
|-------------------|-------------|--------------|--|
| C_{IN}, C_{OUT} | 22 | 0805 | Typical output $V_{pp} \leq 20mV$ in all charge pump modes |
| | | | Typical input ripple $\leq 100mV$ in all charge pump modes |
| C_{BUCKET} | 2.2 | 0603 | Required for the full rated output current |
| C_{BUCKET} | 2.2 | 0402 | Useful for load current up to 300mA |

NOTE: Use only X5R type capacitors, with a 6.3V rating or higher

The highest capacitance values in the smallest package sizes will tend to have poor DC voltage characteristics. The highest value 0402 size capacitor retains as little as 35% of its rated value at 5VDC. The same value chosen in the next larger package size, 0603, will retain about 60% of its rated value at 5VDC.

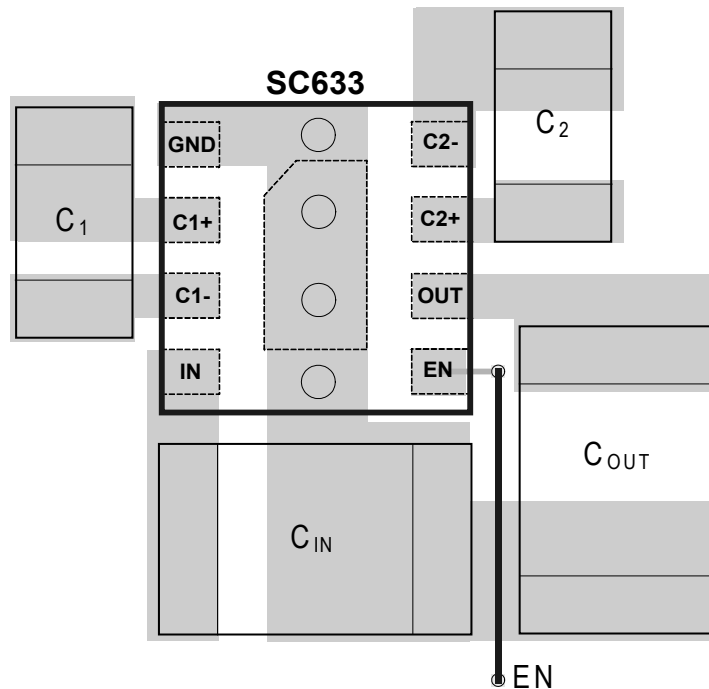
Applications Information (continued)

PCB Layout Considerations

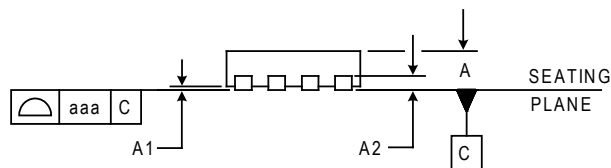
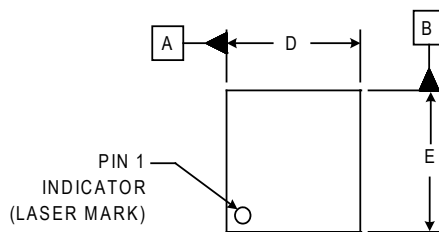
Poor layout can degrade the performance of the regulator and can be a contributory factor in EMI problems, ground bounce, thermal issues, and resistive voltage losses. Poor regulation and instability can result.

The following design rules are recommended:

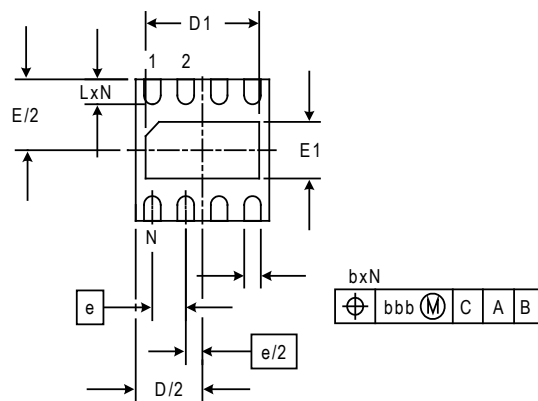
1. Place the bucket capacitors as close to the device as possible and on the same side of the board. Use short wide copper areas between the capacitor pins and the device pins.
2. Place the input and output decoupling capacitors as close as possible to the device and connect these capacitors' ground pads together to the ground plane using multiple vias through a short wide copper area.
3. Connect pin 1 directly to the copper area under the thermal pad.
4. The thermal pad at the center of the device is not electrically connected. Connect this pad to the ground plane using multiple vias.
5. Use a ground plane to further reduce noise interference on sensitive circuit nodes.



Outline Drawing — MLPD-UT-8 2x2



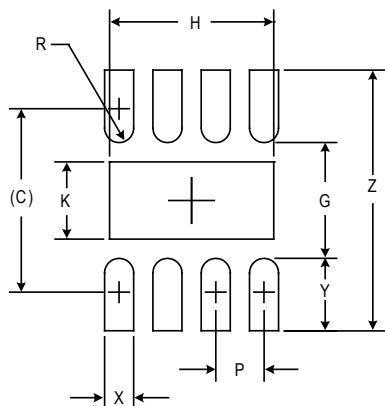
| DIM | INCHES | | | MILLIMETERS | | |
|-----|----------|------|------|-------------|------|------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | .020 | - | .024 | 0.50 | - | 0.60 |
| A1 | .000 | - | .002 | 0.00 | - | 0.05 |
| A2 | (.006) | | | (0.1524) | | |
| b | .007 | .010 | .012 | 0.18 | 0.25 | 0.30 |
| D | .075 | .079 | .083 | 1.90 | 2.00 | 2.10 |
| D1 | .061 | .067 | .071 | 1.55 | 1.70 | 1.80 |
| E | .075 | .079 | .083 | 1.90 | 2.00 | 2.10 |
| E1 | .026 | .031 | .035 | 0.65 | 0.80 | 0.90 |
| e | .020 BSC | | | 0.50 BSC | | |
| L | .012 | .014 | .016 | 0.30 | 0.35 | 0.40 |
| N | 8 | | | 8 | | |
| aaa | .003 | | | 0.08 | | |
| bbb | .004 | | | 0.10 | | |



NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

Land Pattern — MLPD-UT-8 2x2



| DIMENSIONS | | |
|------------|--------|-------------|
| DIM | INCHES | MILLIMETERS |
| C | (.077) | (1.95) |
| G | .047 | 1.20 |
| H | .067 | 1.70 |
| K | .031 | 0.80 |
| P | .020 | 0.50 |
| R | .006 | 0.15 |
| X | .012 | 0.30 |
| Y | .030 | 0.75 |
| Z | .106 | 2.70 |

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.
3. THERMAL VIAS IN THE LAND PATTERN OF THE EXPOSED PAD SHALL BE CONNECTED TO A SYSTEM GROUND PLANE. FAILURE TO DO SO MAY COMPROMISE THE THERMAL AND/OR FUNCTIONAL PERFORMANCE OF THE DEVICE.

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